504753936 01/30/2018

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KARL LAI	01/29/2018

RECEIVING PARTY DATA

Name:	THE SUNLOCK COMPANY, LTD.
Street Address:	ROOM 5, BLOCK C, 16/F,
Internal Address:	HANG WAI INDUSTRIAL CENTER, 6 KIN TAI STREET
City:	TUEN MUN, N.T.
State/Country:	HONG KONG

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	15883598	

CORRESPONDENCE DATA

Fax Number: (203)261-5676

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 203-261-1234

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Correspondent Name: WARE, FRESSOLA, MAGUIRE & BARBER LLP

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Address Line 2: 755 MAIN STREET

Address Line 4: MONROE, CONNECTICUT 06468

ATTORNEY DOCKET NUMBER:	340-802.063
NAME OF SUBMITTER:	KENNETH Q. LAO
SIGNATURE:	/Kenneth Q. Lao/
DATE SIGNED:	01/30/2018

Total Attachments: 2

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PATENT 504753936 REEL: 044771 FRAME: 0653

ASSIGNMENT AND AGREEMENT

FOR VALUE RECEIVED, I, Karl LAI, a citizen of Hong Kong residing at House 20, Constellation Cove, 1 Hung Lam Drive, Tai Po, N.T., Hong Kong, hereby sell, assign and transfer to THE SUN LOCK COMPANY, LTD., an organization duly organized and existing under the laws of Hong Kong, and having a principal place of business at Room 5, Block C, 16/F, Hang Wai industrial Center, 6 Kin Tai Street, Tuen Mun, N.T., Hong Kong, as assignee, and its successors, assigns and legal representatives, the entire right, title and interest, for all countries in and to certain inventions relating to improvements in an *Electronic combination lock with different levels of access control*, which is described in an application for Letters Patent of the United States executed by me on even date herewith, and all the rights and privileges under any and all Letters Patent that may be granted therefor.

I request that any and all patents for said inventions in all countries be issued to said assignee, its successors, assigns and legal representatives, or to such nominees as it may designate.

I agree that, when requested, I will, without charge to said assignee but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said inventions in any and all countries and for vesting title thereto in said assignee, its successors, assigns and legal representatives or nominees.

I authorize and empower the said assignee, its successors, assigns and legal representatives or nominees, to invoke and claim for any application for patent or other form of protection for said inventions filed by it or them, the benefit of the right of priority provided by: (a) any and all other applications for letters patent on said inventions in whatsoever countries, including all divisional, renewal, substitute and continuation applications based in whole or in part upon said inventions; (b) the International Convention for the Protection of Industrial property, as amended, or by convention which may henceforth be substituted for it; and (c) the Patent Cooperation Treaty, as amended, or by any treaty which may henceforth be substituted for it; and to invoke and claim such right of priority without further written or oral authorization from me.

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PATENT REEL: 044771 FRAME: 0654 I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any assignment, consent to file or like document which may be required in any country for any purpose and more particularly in proof of the right of the said assignee or nominee to claim the aforesaid benefit of the right of priority provided by: (a) any and all other applications for letters patent on said inventions in whatsoever countries, including all divisional, renewal, substitute and continuation applications based in whole or in part upon said inventions; (b) the international Convention for the protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it; and (c) the Patent Cooperation Treaty, as amended, or by any treaty which may henceforth be substituted for it.

I covenant with said assignee, its successors and assigns and legal representatives, that the rights and property herein conveyed are free and clear of any encumbrance, and that I have full right to convey the same as herein expressed.

	Signed atHONG	KON G	this Z9
		(city/state/country)	
day of _	January (month)		
		K \$0,1	
		Kari LAi	

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